

Features

- ESD protection for one line with bi-directional
- Provide transient protection for the protected line to
IEC 61000-4-2 (ESD) $\pm 15\text{kV}$ (air) / $\pm 12\text{kV}$ (contact)
IEC 61000-4-5 (Lightning) 4A (8/20 μs)
- **Ultra-low capacitance: 0.15pF typical**
- For low operating voltage applications: **1.5V and below**
- **0201 small DFN package** saves board space
- Fast turn-on and low clamping voltage
- Solid-state silicon-avalanche and active circuit triggering technology
- **Green part**

Applications

- Thunderbolt interface
- USB3.1 and USB3.0 interfaces
- USB Type-C interface
- DisplayPort interface
- Hand held portable applications
- Consumer electronics

Description

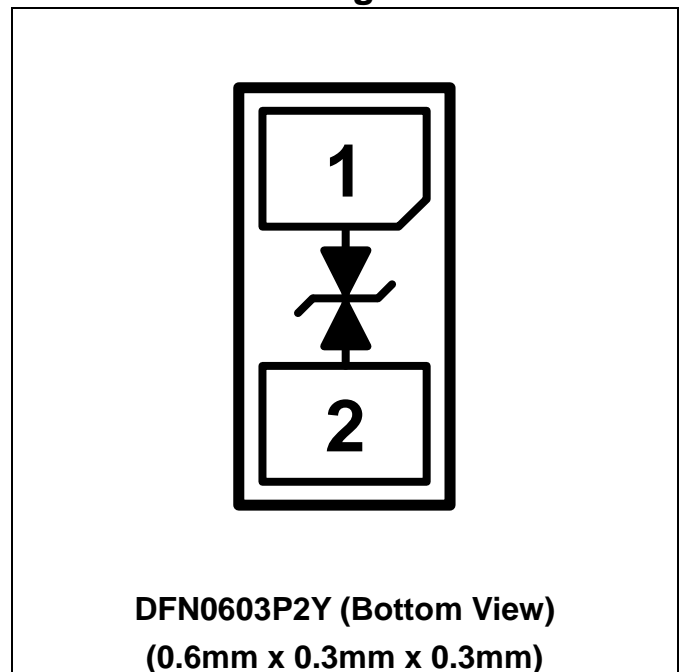
AZ5B8S-01F is a design which includes a bi-directional ESD rated clamping cell to protect high-speed data interfaces in an electronic system. The AZ5B8S-01F has been specifically designed to protect sensitive components which are connected to data and transmission lines from over-voltage caused by Electrostatic Discharging (ESD), Lightning, and Cable Discharge Event (CDE).

AZ5B8S-01F is a unique design which includes proprietary clamping cell with ultra-low capacitance in a small package. During transient conditions, the proprietary clamping cell prevents over-voltage on the control/data lines, protecting any downstream components.

AZ5B8S-01F is bi-directional and may be used on lines where the signal swings above and below ground.

AZ5B8S-01F may be used to meet the ESD immunity requirements of IEC 61000-4-2, Level 4 ($\pm 15\text{kV}$ air, $\pm 8\text{kV}$ contact discharge).

Circuit Diagram / Pin Configuration





SPECIFICATIONS

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C, unless otherwise specified)			
PARAMETER	SYMBOL	RATING	UNIT
Peak Pulse Current (tp=8/20μs)	I _{pp}	4	A
Operating Supply Voltage	V _{DC}	±1.65	V
ESD per IEC 61000-4-2 (Air)	V _{ESD-1}	±15	kV
ESD per IEC 61000-4-2 (Contact)	V _{ESD-2}	±12	
Lead Soldering Temperature	T _{SOL}	260 (10 sec.)	°C
Operating Temperature	T _{OP}	-55 to +125	°C
Storage Temperature	T _{STO}	-55 to +150	°C

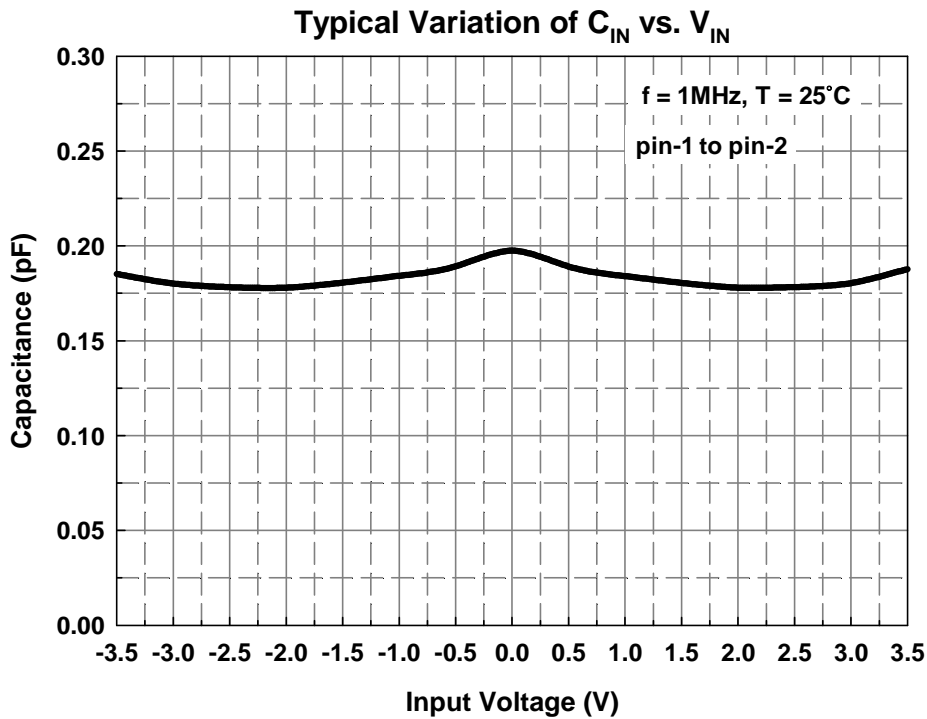
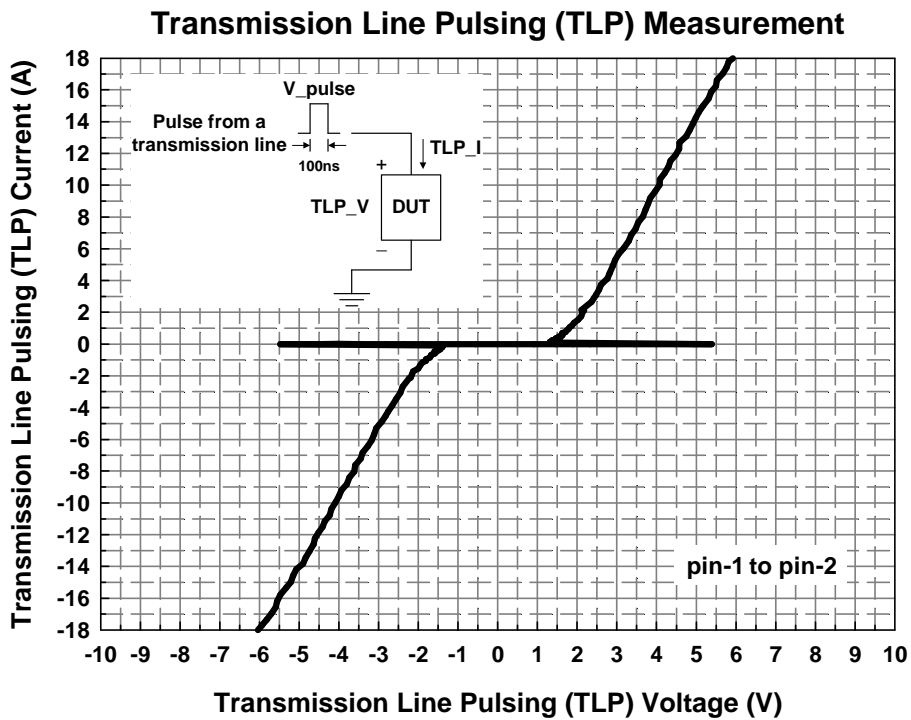
ELECTRICAL CHARACTERISTICS						
PARAMETER	SYMBOL	CONDITION	MIN	TYP	MAX	UNIT
Reverse Stand-Off Voltage	V _{RWM}	T=25 °C.	-1.5		1.5	V
Reverse Leakage Current	I _{Leak}	V _{RWM} = ±1.5V, T=25 °C.			100	nA
Reverse Breakdown Voltage	V _{BV}	I _{BV} = 10μA, T=25 °C.	4			V
ESD Clamping Voltage (Note 1)	V _{CL-ESD}	IEC 61000-4-2 +8kV (I _{TLP} = 16A), Contact mode, T=25 °C.		5.5		V
ESD Dynamic Turn on Resistance	R _{dynamic}	IEC 61000-4-2 0~+8kV, Contact mode, T=25 °C.		0.25		Ω
Channel Input Capacitance	C _{IN}	V _R = 1V, f = 1MHz, T=25 °C.		0.18		pF
		V _R = 1V, f = 1GHz, T=25 °C.		0.15		pF

Note 1: ESD Clamping Voltage was measured by Transmission Line Pulsing (TLP) System.

TLP conditions: Z₀= 50Ω, t_p= 100ns, t_r= 1ns.



Typical Characteristics



Application Information

The AZ5B8S-01F is designed to protect one line against system ESD pulse by clamping it to an acceptable reference. It provides bi-directional protection.

The usage of the AZ5B8S-01F is shown in Fig. 1. Protected line, such as data line, control line, or power line, is connected at pin 1. The pin 2 is connected to a ground plane on the board. In order to minimize parasitic inductance in the board traces, all path lengths connected to the pins of AZ5B8S-01F should be kept as short as possible.

In order to obtain enough suppression of ESD induced transient, a good circuit board is critical. Thus, the following guidelines are recommended:

- Minimize the path length between the protected lines and the AZ5B8S-01F.
- Place the AZ5B8S-01F near the input terminals or connectors to restrict transient coupling.
- The ESD current return path to ground should be kept as short as possible.
- Use ground planes whenever possible.
- NEVER route critical signals near board edges and near the lines which the ESD transient easily injects to.

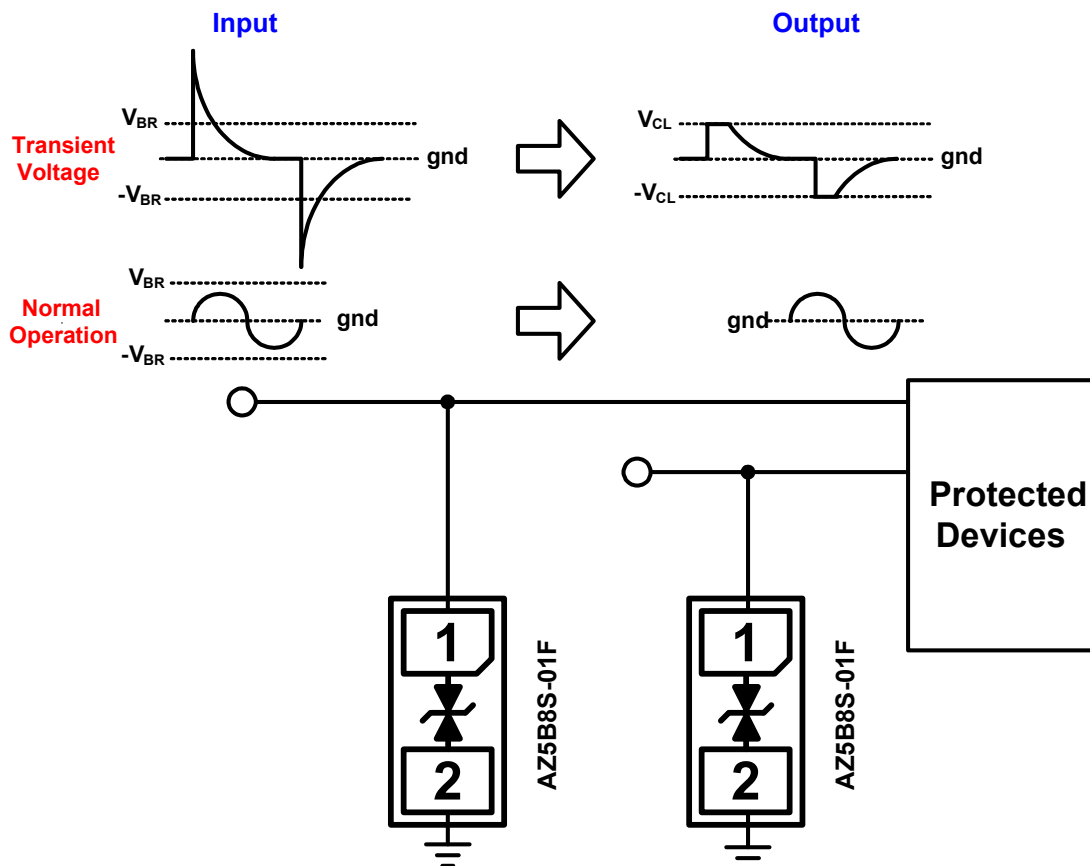
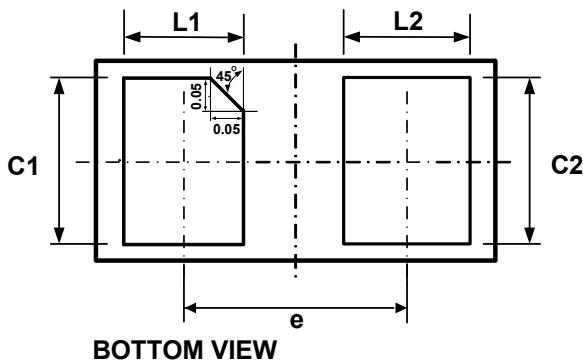
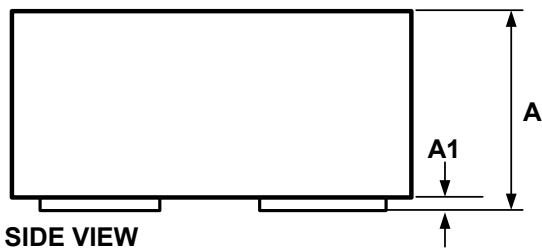
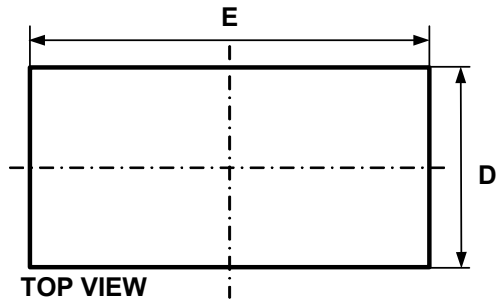


Fig. 1



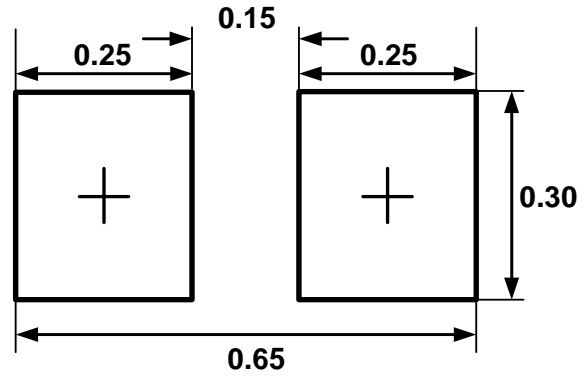
Mechanical Details

DFN0603P2Y PACKAGE DIAGRAMS



SYMBOL	MILLIMETERS		
	MIN.	NOM.	MAX.
E	0.55	0.6	0.65
D	0.25	0.3	0.35
A	0.28	0.3	0.32
A1	0	0.02	0.05
L1	0.13	0.18	0.23
L2	0.14	0.19	0.24
C1/C2	0.2	0.25	0.3
e	0.35 BSC		

LAND LAYOUT

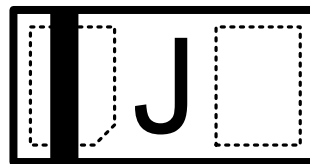


(Unit: mm)

Notes:

This LAND LAYOUT is for reference purposes only. Please consult your manufacturing partners to ensure your company's PCB design guidelines are met.

MARKING CODE



J = Device Code

Part Number	Marking Code
AZ5B8S-01F.R7G (Green Part)	J

Note. Green means Pb-free, RoHS, and Halogen free compliant.



Ordering Information

PN#	Material	Type	Reel size	MOQ	MOQ/internal box	MOQ/carton
AZ5B8S-01F.R7G	Green	T/R	7 inch	12,000/reel	4 reels= 48,000/box	6 boxes =288,000/carton

Revision History

Revision	Modification Description
Revision 2018/12/25	Formal Release.